

PRODUCT SPECIFICATIONS

For Customer: _____ ☐ : APPROVAL FOR SPECIFICATION

Customer Model No. _____ ☐ : APPROVAL FOR SAMPLE

Module No. : LS1010I16-MP-V1

Date : 2022. 07. 06

Version : 01

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For Customer' s Acceptance:

Approved By	Comment

PREPARED	CHECKED	VERIFIED BY QA DEPT	VERIFIED BY R&D DEPT

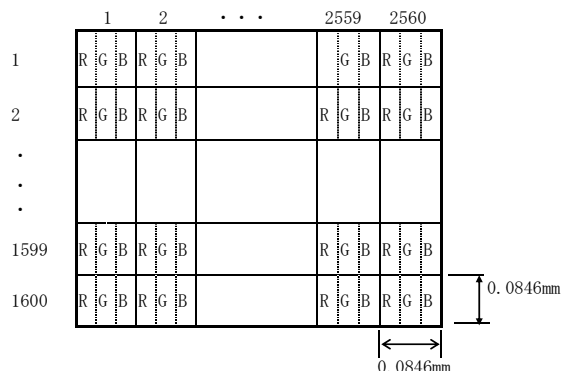
1.BASIC SPECIFICATIONS

1.1 STRUCTURES

LS1010I16-MP-V1" color TFT -LCD (Thin Film Transistor Liquid Crystal Display) module composed of LCD panel , driver ICs ,control circuit, Utilizes a panel with a 16:10 aspect ratio. The 10.1"screen produces a high resolution image that is composed of 2560x1600 pixel elements in a stripe arrangement.

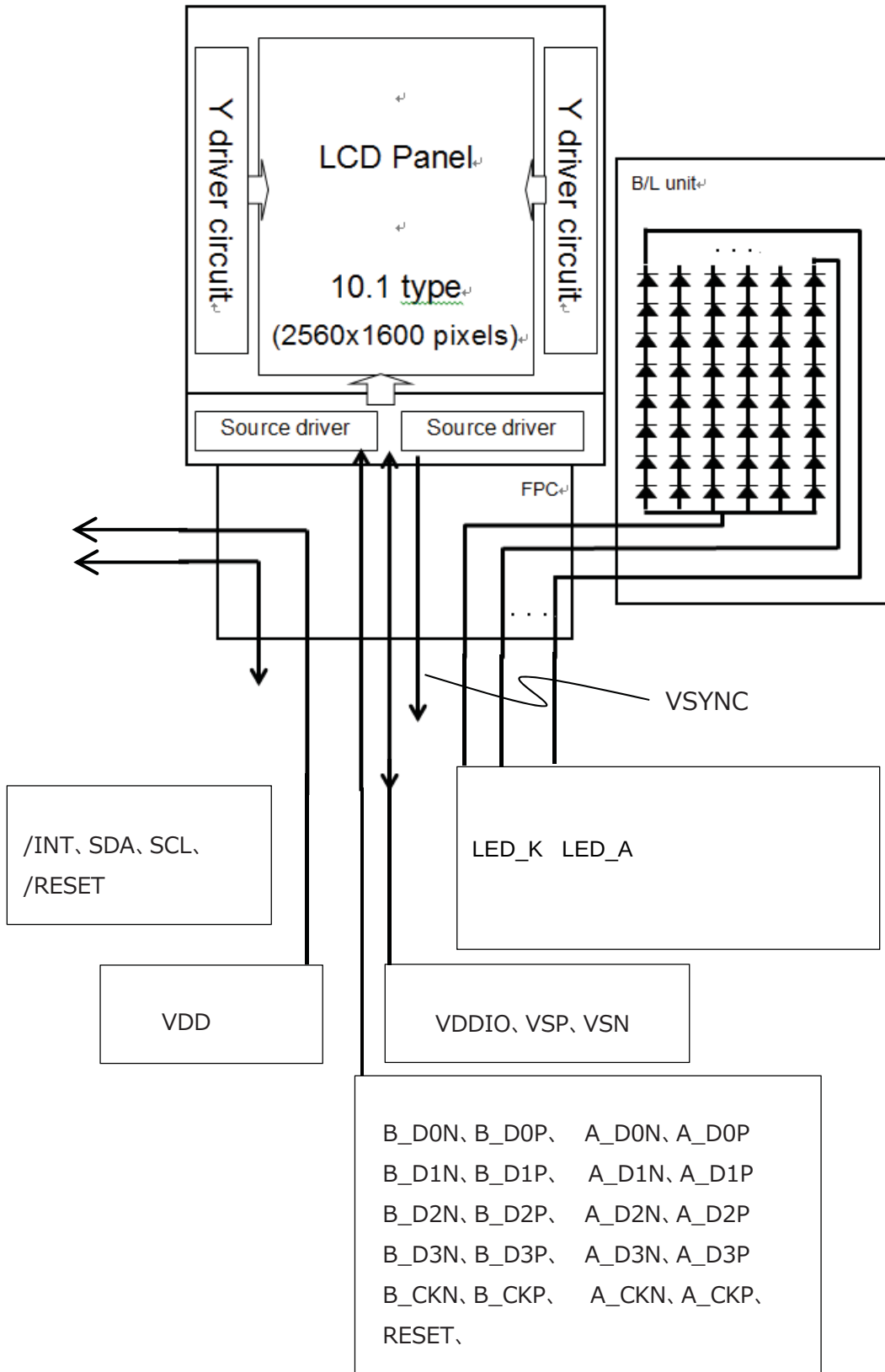
General specifications are summarized in the following table:

		Spec
General	LCD type	IPS
	LCD display supplier	JDI(Japan Display Inc.Group)
	Diagonal size	10.1" Landscape
	Resolution	WQXGA (2560xRGBx1600)
	Active area	216.576 mm(H) x 135.36 mm(V)
	Pixel Pitch	28.2 um(H) x 84.6um(V)
	PPI	300
	Panel Type	LTPS
Interface	Interface	MIPI 4Lane x 2port
Optical	Luminance	Typ.500 cd/m2
	Color gamut	Typ. 77.1% (NTSC) 108.8% (sRGB)
	Contrast	Typ.1000:1
	Number of colors	16M (24bit)
	Viewing angle	L/R/T/B > 80 @CR>10
Back Light	Number of LEDs	48
	LED current	20mA
LCD Panel	Glass size	220.58 mm(H) x 143.76 mm(V) x 0.36mm
	Glass border(L/R/T/B)	2.0/2.0/2.0/6.4
	Glass Thickness	0.36mm(0.18+0.18)
Module	Module structure	LCD panel + FPC + BL
	Module border (L/R/T/B)	2.502 / 2.502 / 2.5 / 6.9
	Module dimensions	221.85 mm(H) x 145.15 mm(V) x 2.0 mm(D) ※ w/o FPC & CG



The LCD Products listed on this document are not suitable for use of aerospace equipments, submarine cables, nuclear reactor control systems and life support systems. If customers intend to use these LCD products for above applications or not listed in "Standard" as follows, please contact our sales people in advance.

1.2 BLOCK DIAGRAM



1.3 INTERFACE PINS

CONNECTOR (FH34SRJ-40S-0.5SH(50))

PIN	SYMBOL	FUNCTION	I/O	REMARKS
1	RESET	Reset Signal	I	Left/Right DSI
2	MIPI_3N_A	MIPI Negative data signal (-)	I	Left DSI
3	MIPI_3P_A	MIPI Positive data signal (+)	I	Left DSI
4	GND	GROUND	P	
5	MIPI_0N_A	MIPI Negative data signal (-)	I/O	Left DSI
6	MIPI_0P_A	MIPI Positive data signal (+)	I/O	Left DSI
7	GND	GROUND	P	
8	MIPI_CKN_A	MIPI Negative data signal (-)	I	Left DSI
9	MIPI_CKP_A	MIPI Positive data signal (+)	I	Left DSI
10	GND	GROUND	P	
11	MIPI_1N_A	MIPI Negative data signal (-)	I	Left DSI
12	MIPI_1P_A	MIPI Positive data signal (+)	I	Left DSI
13	GND	GROUND	P	
14	MIPI_2N_A	MIPI Negative data signal (-)	I	Left DSI
15	MIPI_2P_A	MIPI Positive data signal (+)	I	Left DSI
16	GND	GROUND	P	
17	MIPI_3N_B	MIPI Negative data signal (-)	I	Right DSI
18	MIPI_3P_B	MIPI Positive data signal (+)	I	Right DSI
19	GND	GROUND	P	
20	MIPI_0N_B	MIPI Negative data signal (-)	I/O	Right DSI
21	MIPI_0P_B	MIPI Positive data signal (+)	I/O	Right DSI
22	GND	GROUND	P	
23	MIPI_CKN_B	MIPI Negative data signal (-)	I	Right DSI
24	MIPI_CKP_B	MIPI Positive data signal (+)	I	Right DSI
25	GND	GROUND	P	
26	MIPI_1N_B	MIPI Negative data signal (-)	I	Right DSI
27	MIPI_1P_B	MIPI Positive data signal (+)	I	Right DSI
28	GND	GROUND	P	
29	MIPI_2N_B	MIPI Negative data signal (-)	I	Right DSI
30	MIPI_2P_B	MIPI Positive data signal (+)	I	Right DSI
31	GND	GROUND	P	
32	VDDIO	Power Supply for I/O block	P	
33	VDDIO	Power Supply for I/O block	P	
34	VSN	Power Supply for Analog Circuit	P	
35	VSP	Power Supply for Analog Circuit	P	
36	VSXCN	Tearing Effect Output	O	Right DSI
37	LED_K	LED cathode	P	
38	LED_K	LED cathode	P	
39	LED_A	LED anode	P	
40	LED_A	LED anode	P	

Note) P : Power supply I : Input O : Output

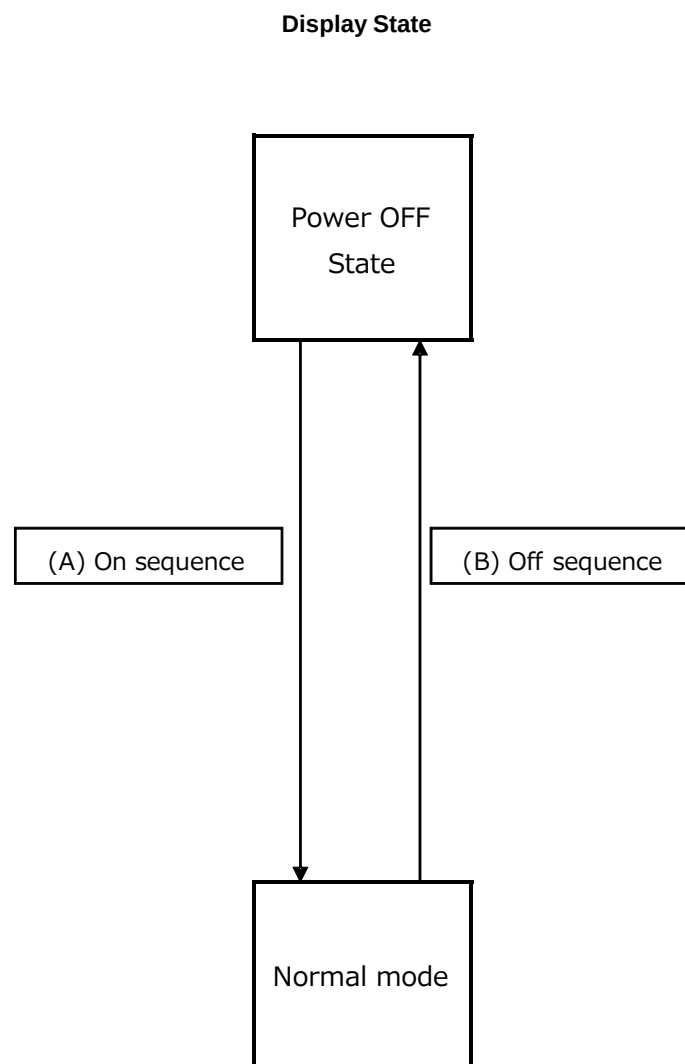
2. FUNCTIONS

The use of LS1010116-MP-V1 LCD basically conforms to specifications of LCD driver IC .It explains typical function in this manual.

2.1 OVERVIEW

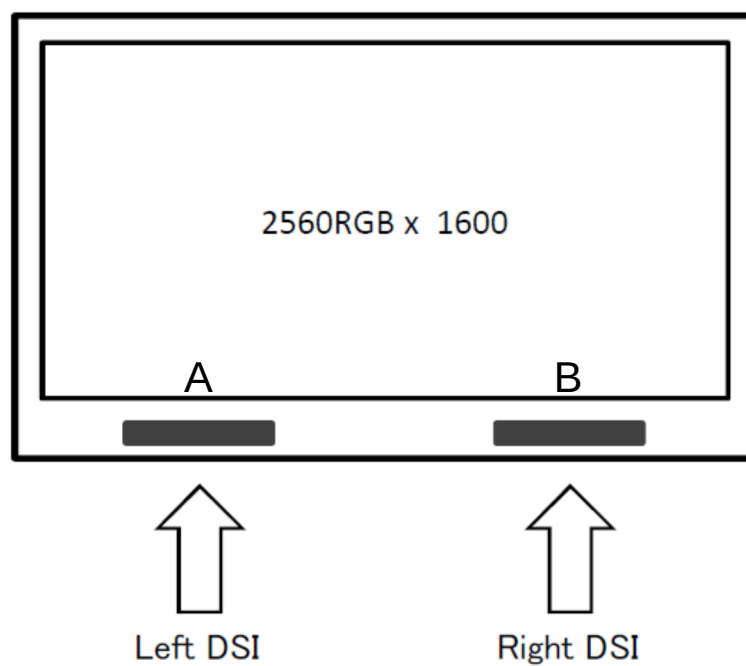
The basic operation mode of this LCD module is illustrated below.

When changing from one mode to another, make sure to follow the sequence indicated in the figure.



2.2 INTERFACE

- MIPI Video mode 4Data Lanes and 2 clock lane with 2ports
- HS(High Speed) Transmission (Unidirectional)
- LP(Low Power) Transmission (Bidirectional)
- Diagnostic function - checksum and ECC error monitoring
- Functionality supported by Escape mode
- Clock Lane supports ULPS
- Packet-Based Protocol



3. ABSOLUTE MAXIMUM RATINGS

GND=0V

Parameter	Symbol	Ratings	Unit	Remarks
power supply voltage	VSP	-0.3~6.5	V	VSP-GND
power supply voltage	VSN	-0.3~6.5	V	GND-VSN
power supply voltage	IOVCC	-0.3~4.6	V	IOVCC-GND
operating temperature range (environmental)	TOP	-10to 60	°C	no dew condition
storage temperature range (environmental)	TST	-20 to 70	°C	no dew condition

Stress beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.

4. ELECTRICAL SPECIFICATIONS

4.1 DC SPECIFICATIONS

4.1.1 DC specifications of general pins

GND = 0V, Ambient temperature = 25°C

Parameter	Symbol	Condition	Ratings			Unit	Pins
			Min.	Typ.	Max.		
Power supply voltage	VSP		5.3	5.4	5.5	V	
Power supply voltage	VSN		-5.5	-5.4	-5.3	V	
Power supply voltage	IOVCC		1.7	1.8	1.9	V	
Low-level input voltage	VIL		0	-	0.3 x IOVCC	V	
High-level input voltage	VIH		0.7 x IOVCC	-	IOVCC	V	
Low-level output voltage	VOL	IOUT=+1mA	0.0	-	0.2 x IOVCC	V	
High-level output voltage	VOH	IOUT=-1mA	0.8 x IOVCC	-	IOVCC	V	
Power supply current(CTF) (RMS) *2) *3)	IVSP		12	17	32	mA	VSP
	IVSN		-18	-16	-10	mA	VSN
	IIOVCC		31	34	90	mA	IOVCC

*1: Rated values indicate operating range of electrical functions.

*2: When it is the power supply voltage Typ.

*3: Display image is "White raster Display shown in describes.

<White raster Display>



ELECTRICAL CHARACTERISTICS

Ta=25°C

ITEM	SYMBOL	MIN	TYP	MAX	UNIT	NOTE
LED Total Input Voltage	VLED	22.4	24	25.6	V	
LED Total Input Current	IBL+	-	120	-	mA	

4.2 AC SPECIFICATIONS

4.2.1 MIPI DSI characteristics

	Item	Symbol	Unit	Test condition	Min.	Typ.	Max.	Note
HS-RX	Differential input high threshold	VIDTH	mV	VDDIO=1.70V~1.90V	-	-	70	3
	Differential input low threshold	VIDTL	mV	VDDIO=1.70V~1.90V	-70	-	-	3
	Single-ended input low voltage	VILHS	mV	VDDIO=1.70V~1.90V	-40	-	-	
	Single-ended input high voltage	VIHHS	mV	VDDIO=1.70V~1.90V	-	-	460	
	Common-mode voltage HS receive mode	VCMRX(DC)	mV	VDDIO=1.70V~1.90V	70	-	330	1
	Differential input impedance	ZID	Ω	VDDIO=1.70V~1.90V	-	100	-	2
LP-RX	Logic 0 input voltage not in ULP State	VIL	mV	VDDIO=1.70V~1.90V	-50	-	550	
	Logic 1 input voltage	VIH	mV	VDDIO=1.70V~1.90V	880	-	1350	
	I/O leakage current	ILEAK	μ A	Vin=-50mV~1350mV	-10	-	10	
LP-TX	Thevenin output low level	VOL	mV	VDDIO=1.70V~1.90V	-50	-	50	
	Thevenin output high level	VOH	V	VDDIO=1.70V~1.90V	1.1	1.2	1.3	
	Output impedance of LP transmitter	ZOLP	Ω	VDDIO=1.80V	110	-	-	2
CD-RX	Logic 0 contention threshold	VILCD	mV	VDDIO=1.70V~1.90V	-	-	200	
	Logic 1 contention threshold	VIHCD	mV	VDDIO=1.70V~1.90V	450	-	-	

Note 1) $V_{CMRX(DC)} = (V_{DP} + V_{DN})/2$

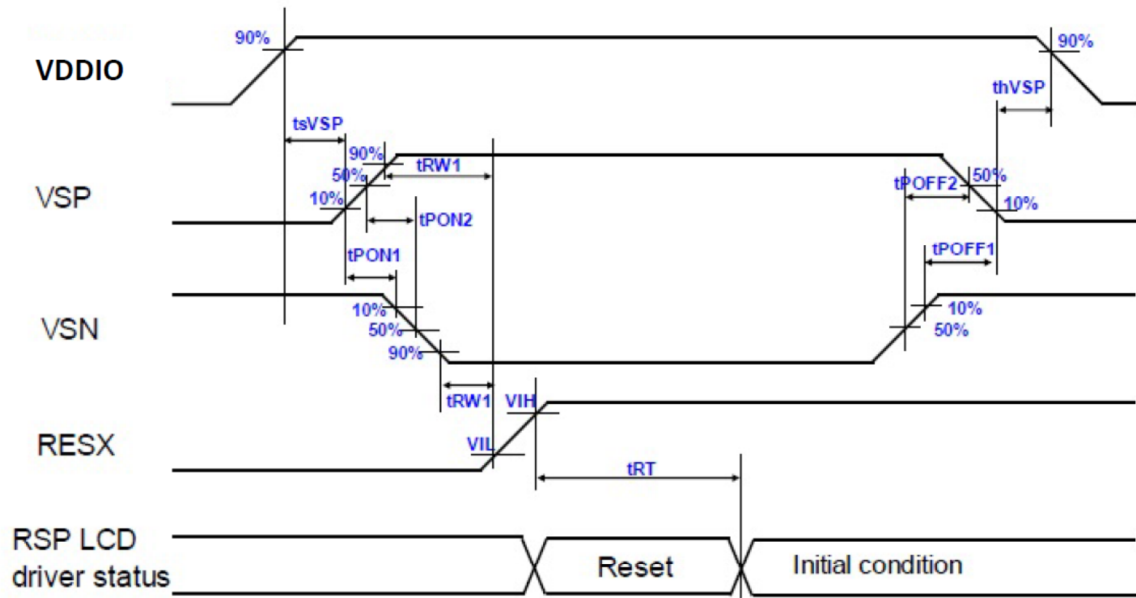
Note 2) Excluding COG resistance (contact resistance and ITO wiring resistance).The values are tentative.

Note 3) Minimum 110mV/-110mV HS differential swing is required for display data transfer.

4.3 RECOMMENDED SEQUENCE

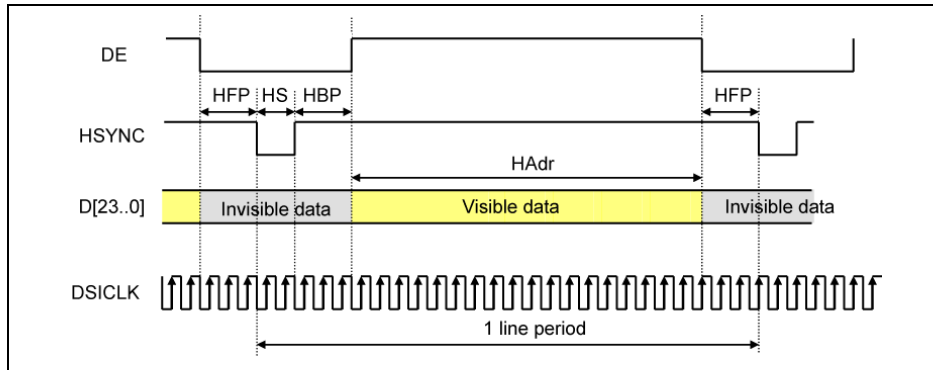
4.3.1 Power On/Off operation and reset operation and Reset Timing

Power Supply Sequence



Item	Symbol	Unit	Test Condition	Min	Max
VSP-VSN delay time (10% to 10%)	tPON1	us	Power On	0	-
VSP-VSN delay time (50% to 50%)	tPON2	us	Power On	0	-
System power on to VSP ON time	tsVSP	ms	Power On	1	-
Reset low-level width1	tRW1	ms	Power On	10	-
Reset time(Sleep IN)	tRT	ms	Power On	10	-
VSN-VSP delay time (10% to 10%)	tPOFF1	us	Power Off	0	-
VSN-VSP delay time (50% to 50%)	tPFF2	us	Power Off	0	-
VSP OFF to system power off time	thVSP	us	Power Off	0	-

Horizontal Display Timing (Video Mode)



Vertical Display Timing (Video Mode, RM = 1h, DM = 3h, Method-1)

Item	Symbol	Condition	Unit	Min.	Typ.	Max.	Notes
Vertical cycle	VP		Line	1608	1616	-	
Vertical low pulse width	VS		Line	1	3	-	See
Vertical front porch	VFP		Line	4	7	-	
Vertical back porch	VBP		Line	4	6	BP-3	See
Vertical data start point	VBP	VS+VBP	Line	5	9	BP-4	See
Vertical blanking period	VBL	VBP+VFP	Line	8	13	-	
Vertical active area	Vadr		Line	-	1600	-	

Note: "VS + VBP" is set as back porch by BP register.

1 line : prescribed by HSYNC (when RM = 2'h0, DM = 4'h1)

prescribed by RTN setting (when RM = 2'h1, DM = 4'h3)

BP : register setting

Vertical Display Timing (Video Mode, RM = 1h, DM = 3h, Method-2)

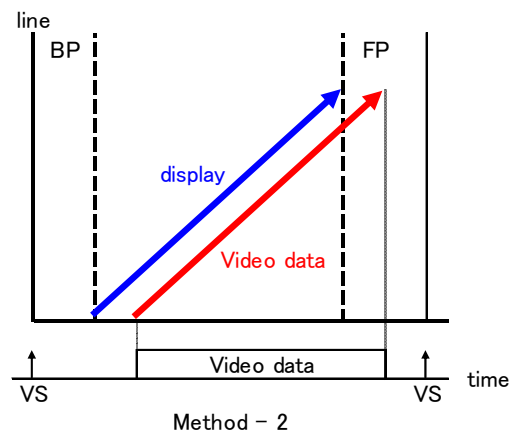
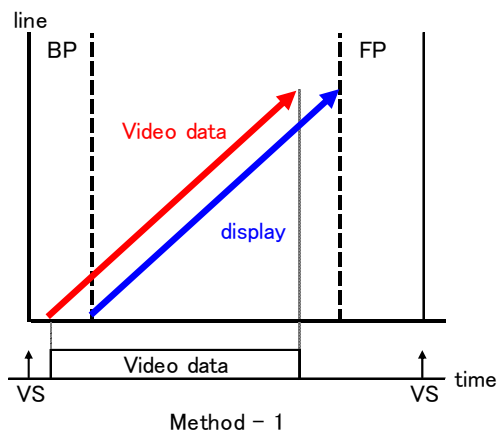
Item	Symbol	Condition	Unit	Min.	Typ.	Max.	Notes
Vertical cycle	VP		Line	1608	1616	-	
Vertical low pulse width	VS		Line	1	3	-	See
Vertical front porch	VFP		Line	4	7	-	
Vertical back porch	VBP		Line	BP+3	6	-	See
Vertical data start point	VBP	VS+VBP	Line	BP+4	9	-	See
Vertical blanking period	VBL	VBP+VFP	Line	BP+7	13	-	See
Vertical active area	Vadr		Line	-	1600	-	

Note: "VS + VBP" is set as back porch by BP register.

1 line : prescribed by HSYNC (when RM = 2'h0, DM = 4'h1)

prescribed by RTN setting (when RM = 2'h1, DM = 4'h3)

BP : register setting



Horizontal Display Timing (Video Mode, RM = 1h, DM = 3h)

Item	Symbol	Condition	Unit	Min.	Typ.	Max.	Notes
Horizontal front porch	HFP		ByteClock	4lane:100+β	-	-	
Horizontal data start point	-	HS+HBP	ByteClock	45+α	-	-	
Horizontal active area	Hadr		Pixel	-	1280	-	2Chip

Note: $f_{ByteClock} = (1/4) * f_{DSICLK}$. $f_{ByteClock}$ = frequency of ByteClock.

$\alpha, \beta \leq 45 \text{ ByteClock}$

Please refer to the following restrictions about α, β .

Vertical Display Timing (Video Mode, DM = 1h)

Item	Symbol	Condition	Unit	Min.	Typ.	Max.	Notes
Vertical cycle	VP		Line	1608	1616	-	
Vertical low pulse width	VS		Line	1	3	-	See
Vertical front porch	VFP		Line	4	7	-	
Vertical back porch	VBP		Line	4	6	-	See
Vertical data start point	VBP	VS+VBP	Line	5	9	-	
Vertical blanking period	VBL	VBP+VFP	Line	8	13	-	
Vertical active area	Vadr		Line	-	1600	-	

Note: "VS + VBP" is set as back porch by BP register.

1 line : prescribed by HSYNC (when RM = 2'h0, DM = 4'h1)

prescribed by RTN setting (when RM = 2'h1, DM = 4'h3)

Horizontal Display Timing (Video Mode, RM = 0h, DM = 1h)

Item	Symbol	Condition	Unit	Min.	Typ.	Max.	Notes
Horizontal front porch	HFP		ByteClock	4lane:100+β	-	-	
Horizontal data start point	-	HS+HBP	ByteClock	45+α	-	-	
Horizontal active area	Hadr		Pixel	-	1280	-	2Chip

Note: $f_{ByteClock} = (1/4) * f_{DSICLK}$. $f_{ByteClock}$ = frequency of ByteClock.

$\alpha, \beta \leq 45 \text{ ByteClock}$

Please refer to the following restrictions about α, β .

Timing restrictions in Video mode of Two Chips

The blanking period is specified for the pixel data transfer to the two chips in Video Mode.

Set 45 ByteClock or less in the time that the pixel data transfer to the Second(Slave) chip precedes and is behind the pixel data transfer to the First(Master) chip.

α : Time the pixel data is transferred to the Second(Slave) chip(CPUS=1, CPPOS=1) precedes time the pixel data is transferred to the First(Master) chip(CPUS=1, CPPOS=0).

β : Time the pixel data is transferred to the Second(Slave) chip(CPUS=1, CPPOS=1) is behind time the pixel data is transferred to the First(Master) chip(CPUS=1, CPPOS=0).

4.3.3 Power On Sequence

Step	DataTyp (Hex)	index (Hex)	Parameter (Hex)	Delay	L/R	Command
1						Power Supply (VDDIO=1.8V)
2				5ms		
3						Power Supply (VSP=5.4V)
4				8ms		
5						Power Supply (VSN=-5.4V)
6				10ms		
7						RESET L→H (100ms)→L(200ms)→H
8				200ms		
9	23	0xB0	0x00		L/R	MCAP
10	23	0XD6	0x01		L/R	T_SLPOUT=0(NVM load stop)
11	29	0XB3	0x14		L/R	Interface setting
			0x08			
			0x00			
			0x22			
			0x00			
11				100ms		
12	05	0X29			L/R	Display on
13	05	0X11				Sleep out
14				100ms		
15						Backlight turn on

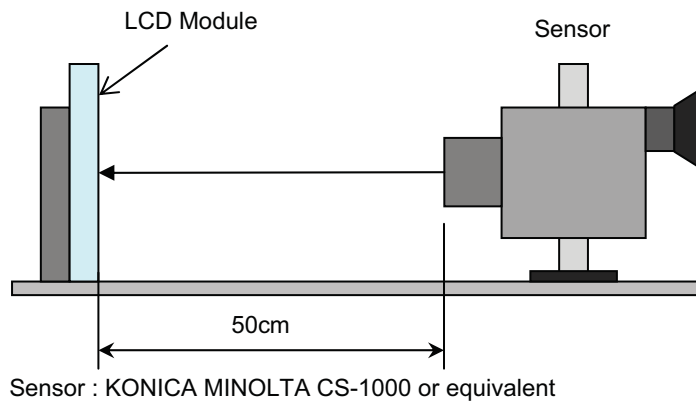
4.3.3 Power Off Sequence

Step	DataTyp (Hex)	index (Hex)	Parameter (Hex)	Delay	L/R	Command
1						Backlight turn off
2				100ms		
3	05	0x28			L/R	Display off
4				100ms		
7	05	0x10			L/R	Sleep in
8				150ms		
9						Power off

5. OPTICAL CHARACTERISTICS

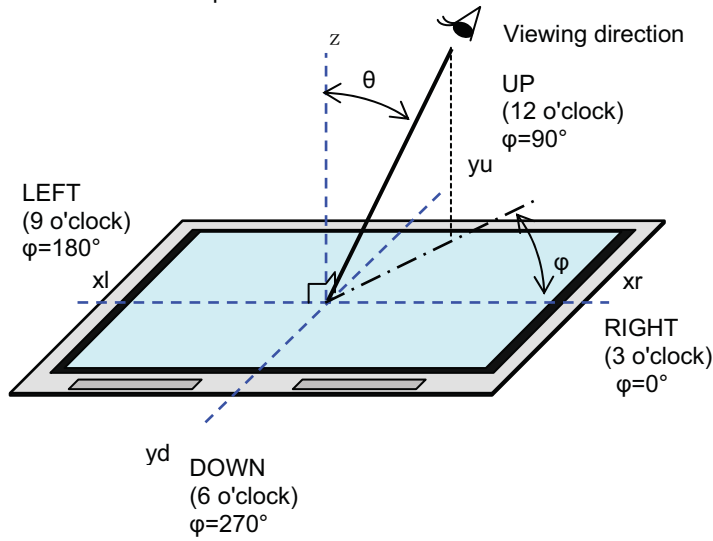
Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Notes
Brightness		B	$\varphi=0^{\circ}$, $\theta=0^{\circ}$	-	(500)	-	Cd/m2	(1),(2)
Viewing Angle on axis	$\varphi=0$	θ	CR>10	(80)	-	-	degree	(3),(4)
	$\varphi=90$							
	$\varphi=180$							
	$\varphi=270$							
Contrast Ratio		CR	$\varphi=0^{\circ}$, $\theta=0^{\circ}$	-	(1200)	-	-	(5)
Color Gamut CIE 1931 (Primary Color)	Red	x	$\varphi=0^{\circ}$, $\theta=0^{\circ}$	-	0.6379	-	-	-
		y		-	0.3393	-		
	Green	x		-	0.3179	-		
		y		-	0.647	-		
	Blue	x		-	0.1502	-		
		y		-	0.0461	-		
	White	x		-	0.2911	-		
		y		-	0.3082	-		
NTSC Ratio (CIE1931)		-	$\varphi=0^{\circ}$, $\theta=0^{\circ}$	-	(77)	-	-	
Gamma Curve		-	$\varphi=0^{\circ}$, $\theta=0^{\circ}$	-	(2.2)	-	-	
Cross Talk		CT	-	-	-	(4)	%	(6)

Notes (1) Definition of Brightness "B". At the Center of Active Area.

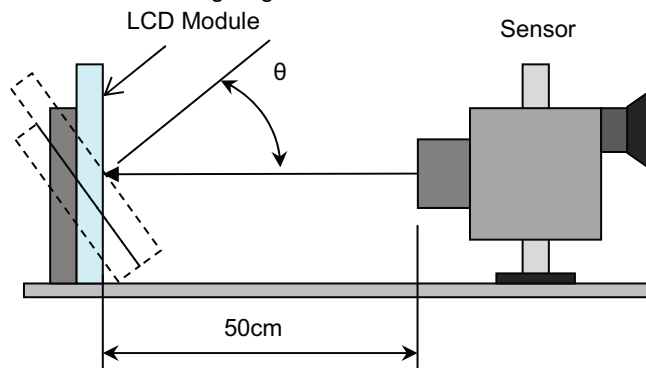


(2) Display image for measurement : All White

(3) Definition of θ and φ



(4) Definition of Viewing Angle θ



Sensor : TOPCON's BM-5A or equivalent

(5) Definition of Contrast "CR"

$CR = (\text{Brightness when displaying White raster}) / (\text{Brightness when displaying Black raster})$

10 60 70

(6) Definition of Cross Talk "CT"

$CT = \{(\text{Brightness [Cross-talk pattern]} - \text{Brightness [127Gray]}) / (\text{Brightness [127Gray]}) \times 100(\%)$

Measurement pattern :

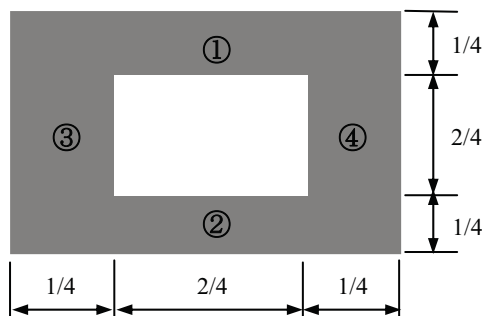
Cross talk pattern 1 : White box

Cross talk pattern 2 : Black box

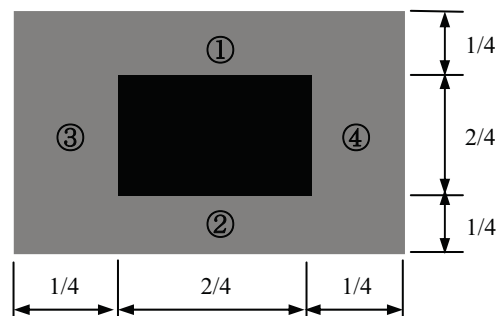
Measurement Point :

Vertical Crosstalk : ① and ②

Horizontal Crosstalk : ③ and ④



Cross talk pattern 1 : White box



Cross talk pattern 2 : Black box

